

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,971,875 B2
APPLICATION NO. : 10/017455
DATED : December 6, 2005
INVENTOR(S) : Densen Cao

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 16

Line 60, replace the phrase "light emitting semiconductor device" with "light emitting semiconductor chip"

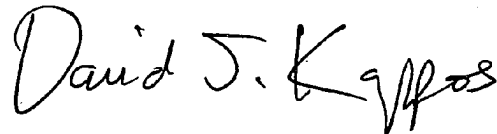
Line 66, replace the phrase "light emitting semiconductor device" with "light emitting semiconductor chip"

Column 18

Line 22, replace the phrase "said primary elongate heat sink" with "said elongate heat sink"

Signed and Sealed this

Eighth Day of December, 2009

A handwritten signature in black ink, reading "David J. Kappos". The signature is written in a cursive, flowing style with a large initial 'D' and a stylized 'K'.

David J. Kappos
Director of the United States Patent and Trademark Office